



FEATURES

- Support Intel LGA1151/6~9th gen processor.
- 2*SO-DIMM DDR4 Memory, Max up to 64GB.
- Support 3*HDMI independence.
- Intel Q250.
- 2*Intel I210AT
- 6* RS-232 DB9.
- 6*USB3.0 ,2*USB2.0, Inbuild 1*USB2.0.
- Support DIO 7 in 7 out with isolation.
- Support DC 9~36V Wide pressure.
- The fan dissipates heat with the copper pipe.

EBC-01026	
CPU	Intel LGA1151 /6~9 th gen processor
CHIPSET	Intel Q250
MEMORY	2*SODIMM DDR4 memory, Max up to 64GB
STORAGE	1*2.5inch HDD, 1*mSATA (IO), 1*M.2/SSD, Support Key-M, 2280, NVME PCIe4 SSD
HDMI	4*HDMI 2.0, Supports asynchronous triple display
USB	4*USB3.0, 2*USB3.0, 2*USB2.0, In build 1*USB2.0
COM	4*RS-232 DB9, COM3~4 support RS-232/485/S422, COM1~2 support CAN (Need to load CAN module)
LAN	2*Intel I210AT (M12)
GPIO	7 in 7out
EXPANSION SLOT	1*MINIPcie, Support WiFi or 4G Module 1*M.2/WiFi, Support Key-E, 2230, WiFi Module 1*M.2/5G, Support Key-B, 3042/3052, 5G Module
AUDIO	1*Audio, Line out with Mic All in one
GPIO	14x GPIO (7 input, 7 output)
SIM	1*SIM (Default M.2 5G)
BUTTON	1*Power button, 1*One-key recovery button, 1*AC LOSS switch (auto ON/OFF)
LED	1*HDD LED
POWER OUTPUT	>AC TO DC 90W
POWER SUPPLY	9 to 36V wide voltage input
PHOENIX TERMINAL	M12 Connector, 9 to 36V wide voltage input
OPERATION SYSTEM	Windows® 10, LINUX
OPERATING TEMPERATURE	-10°C ~ 70°C
STORAGE TEMPERATURE	-20°C ~ 80°C
RELATIVE HUMIDITY	5%-95% relative humidity, non-condensing
DIMENSION	229*208*67.7MM
CERTIFICATION	CE, FCC
WARRANTY	2 Years